

**TOSHIBA**

**2SK2838**

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE ( $\pi$ -MOS V)

# 2SK2838

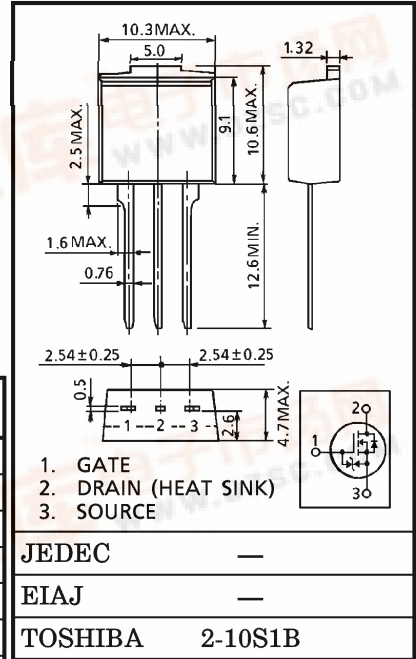
HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS  
 CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

INDUSTRIAL APPLICATIONS  
 TO-220FL Unit in mm

- Low Drain-Source ON Resistance :  $R_{DS(ON)} = 0.84\Omega$  (Typ.)
- High Forward Transfer Admittance :  $|Y_{fs}| = 4.4S$  (Typ.)
- Low Leakage Current :  $I_{DSS} = 100\mu A$  (Max.) ( $V_{DS} = 400V$ )
- Enhancement-Mode :  $V_{th} = 2.0 \sim 4.0V$  ( $V_{DS} = 10V, I_D = 1mA$ )

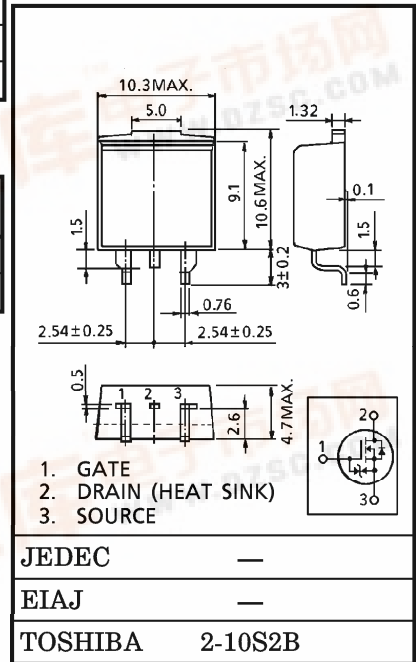
MAXIMUM RATINGS ( $T_a = 25^\circ C$ )

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		$V_{DSS}$	400	V
Drain-Gate Voltage ( $R_{GS} = 20k\Omega$ )		$V_{DGR}$	400	V
Gate-Source Voltage		$V_{GSS}$	$\pm 30$	V
Drain Current	DC	$I_D$	5.5	A
	Pulse	$I_{DP}$	22	A
Drain Power Dissipation ( $T_c = 25^\circ C$ )		$P_D$	40	W
Single Pulse Avalanche Energy**		$E_{AS}$	223	mJ
Avalanche Current		$I_{AR}$	5.5	A
Repetitive Avalanche Energy*		$E_{AR}$	4.0	mJ
Channel Temperature		$T_{ch}$	150	$^\circ C$
Storage Temperature Range		$T_{stg}$	$-55 \sim 150$	$^\circ C$



Weight : 1.5g

TO-220SM



Weight : 1.5g

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	3.125	$^\circ C / W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	83.3	$^\circ C / W$

Note ;

\* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

\*\*  $V_{DD} = 90V$ , Starting  $T_{ch} = 25^\circ C$ ,  $L = 12.0mH$   
 $R_G = 25\Omega$ ,  $I_{AR} = 5.5A$  (See Figure)

This transistor is an electrostatic sensitive device.  
 Please handle with caution.

961001EAA2

• TOSHIBA is continually working to improve the quality and the reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to observe standards of safety, and to avoid situations in which a malfunction or failure of a TOSHIBA product could cause loss of human life, bodily injury or damage to property. In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as set forth in the most recent products specifications. Also, please keep in mind the precautions and conditions set forth in the TOSHIBA Semiconductor Reliability Handbook.



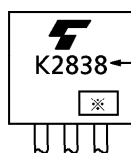
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±25V, V <sub>DS</sub> = 0V	—	—	±10	μA	
Gate-Source Breakdown Voltage	V (BR) GSS	I <sub>G</sub> = ±10μA, V <sub>DS</sub> = 0V	±30	—	—	V	
Drain Cut-off Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400V, V <sub>GS</sub> = 0V	—	—	100	μA	
Drain-Source Breakdown Voltage	V (BR) DSS	I <sub>D</sub> = 10mA, V <sub>GS</sub> = 0V	400	—	—	V	
Gate Threshold Voltage	V <sub>th</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA	2.0	—	4.0	V	
Drain-Source ON Resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 3A	—	0.84	1.2	Ω	
Forward Transfer Admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 3A	2.0	4.4	—	S	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1MHz	—	720	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>		—	80	—		
Output Capacitance	C <sub>oss</sub>		—	250	—		
Switching Time	Rise Time	t <sub>r</sub>		—	15	—	ns
	Turn-on Time	t <sub>on</sub>		—	30	—	
	Fall Time	t <sub>f</sub>		—	25	—	
	Turn-off Time	t <sub>off</sub>		V <sub>IN</sub> : t <sub>r</sub> , t <sub>f</sub> < 5ns, Duty ≤ 1%, t <sub>w</sub> = 10μs	—	110	
Total Gate Charge (Gate-Source Plus Gate-Drain)	Q <sub>g</sub>	V <sub>DD</sub> = 320V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 5.5A	—	17	—	nC	
Gate-Source Charge	Q <sub>gs</sub>		—	10	—		
Gate-Drain ("Miller") Charge	Q <sub>gd</sub>		—	7	—		

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)<sub>z</sub>

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I <sub>DR</sub>	—	—	—	5.5	A
Pulse Drain Reverse Current	I <sub>DRP</sub>	—	—	—	22	A
Diode Forward Voltage	V <sub>DSF</sub>	I <sub>DR</sub> = 5.5A, V <sub>GS</sub> = 0V	—	—	-1.7	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>DR</sub> = 5.5A, V <sub>GS</sub> = 0V	—	350	—	ns
Reverse Recovery Charge	Q <sub>rr</sub>	dI <sub>DR</sub> / dt = 100A / μs	—	2.1	—	μC

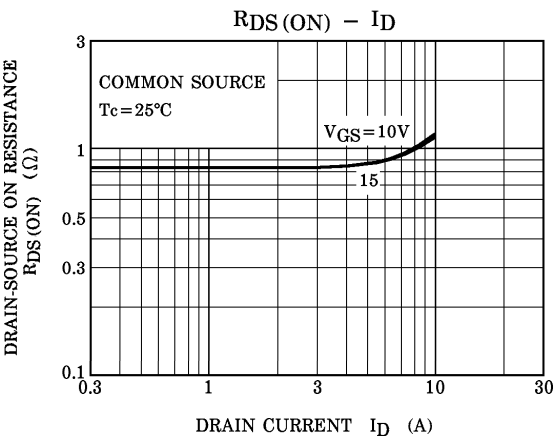
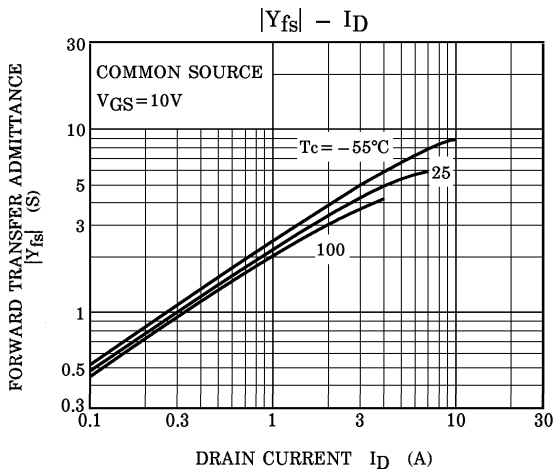
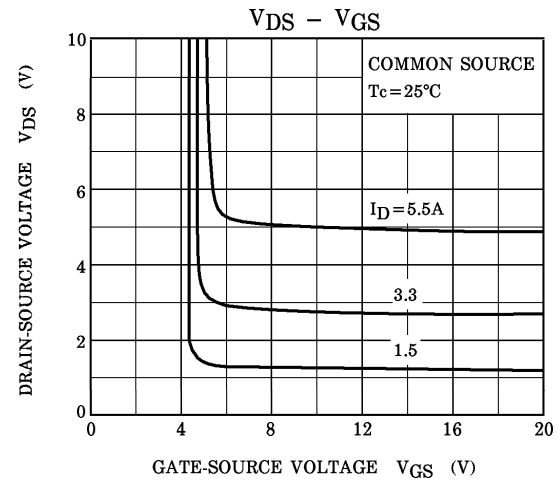
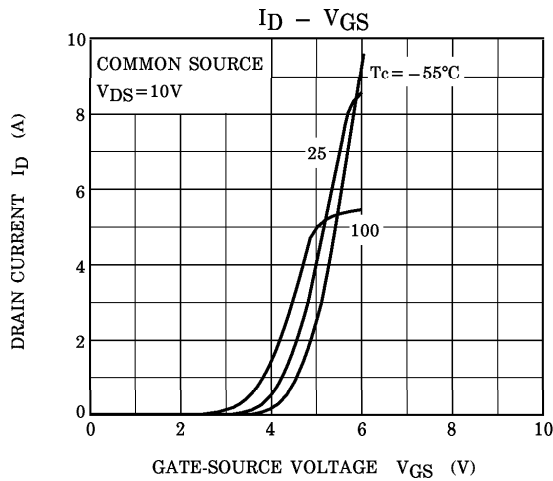
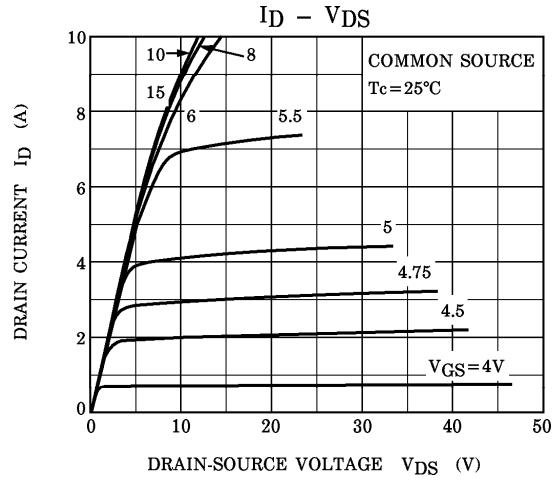
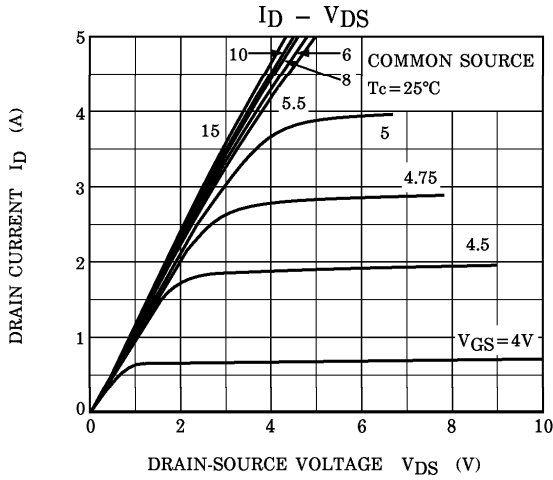
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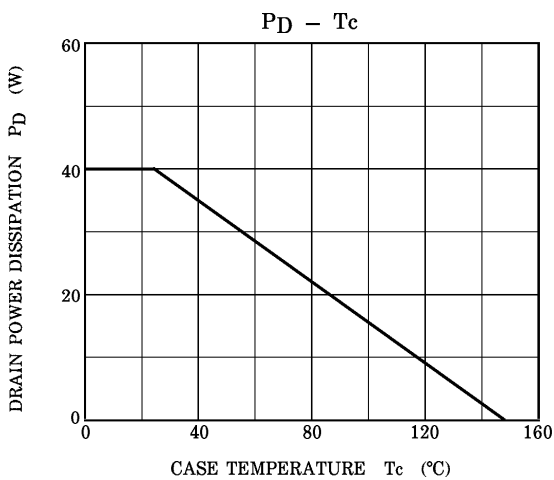
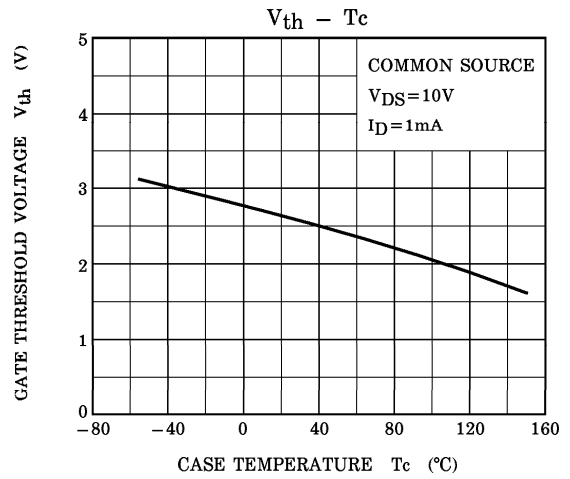
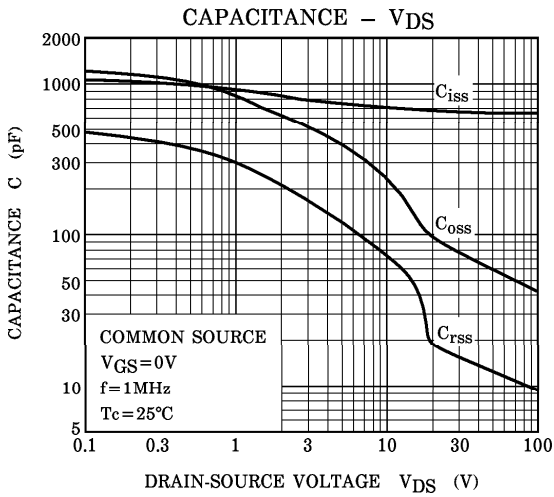
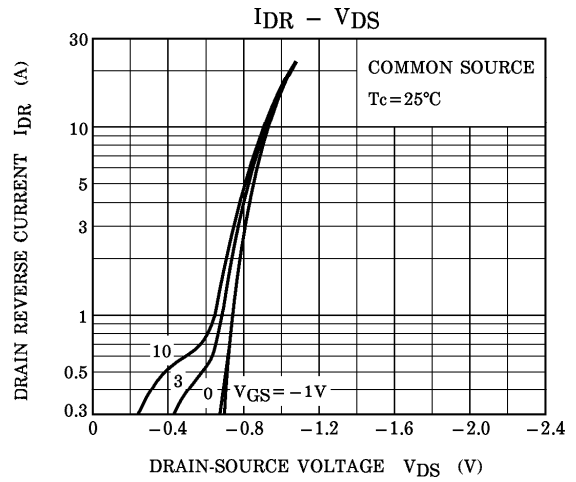
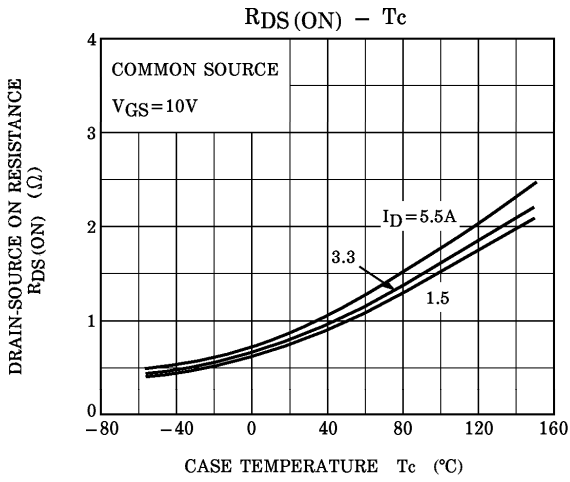


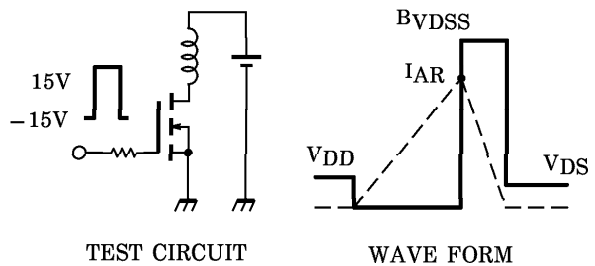
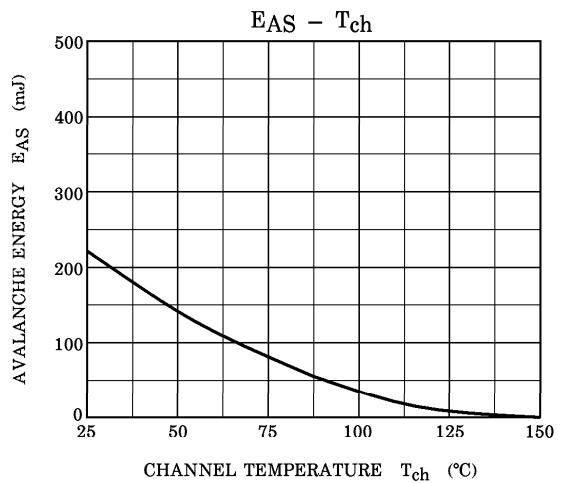
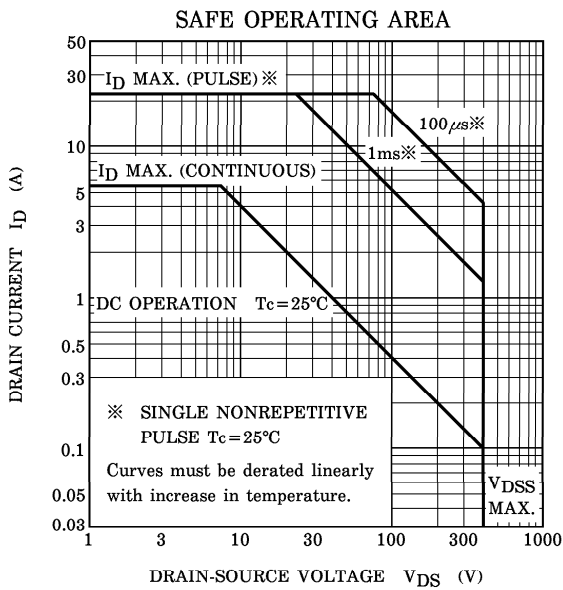
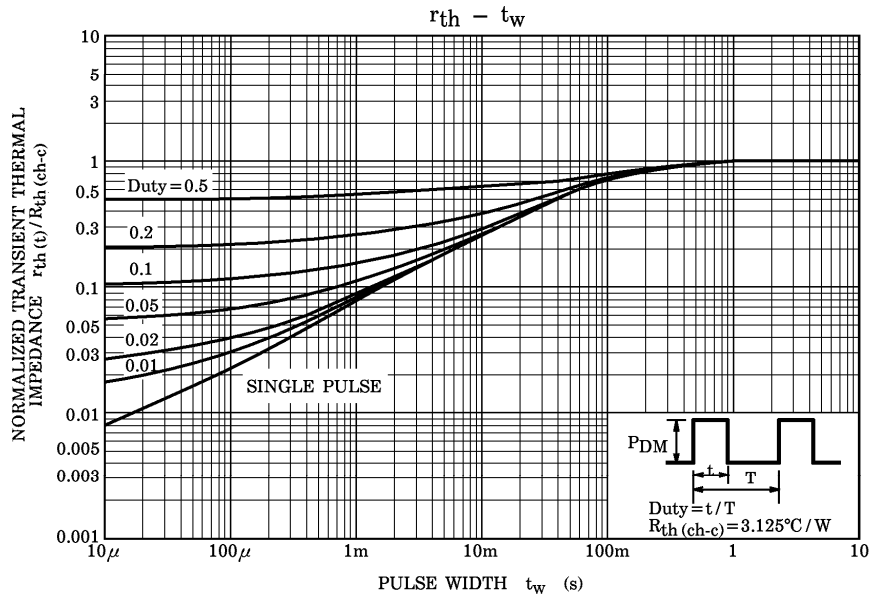
TYPE → K2838  
 ※ Lot Number  
 □ □ — Month (Starting from Alphabet A)  
 — Year (Last Number of the Christian Era)

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Peak  $I_{AR} = 5.5A$ ,  $R_G = 25\Omega$

$V_{DD} = 90V$ ,  $L = 12mH$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$